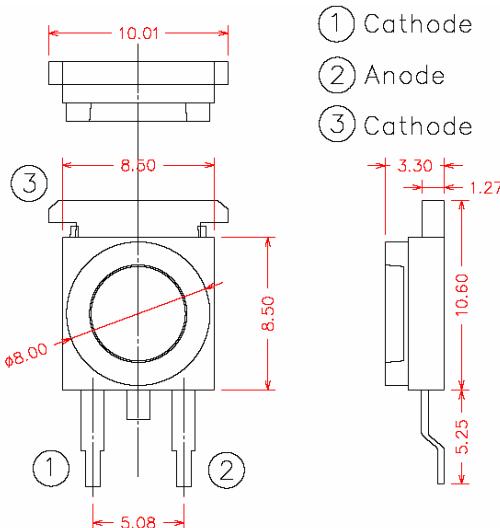


Color	Type	Technology	Case
Blue	B-470-T110-350	InGaN/Al <sub>2</sub> O <sub>3</sub>	TO220, short pins



#### Maximum Ratings at T<sub>a</sub> = 25°C

Parameter	Test conditions	Symbol	Value	Unit
Forward current		I <sub>F</sub>	350	mA
Peak forward current	Duty 1/100, f≤1 kHz	I <sub>FP</sub>	500	mA
Power dissipation		P <sub>D</sub>	1.5	W
Reverse voltage	I <sub>R</sub> =10 μA	V <sub>R</sub>	5	V
Reverse current	U <sub>R</sub> =5 V	I <sub>R</sub>	50	μA
Operating temperature		T <sub>opr</sub>	-20 to +70	°C
Storage temperature		T <sub>stg</sub>	-40 to +85	°C
Soldering temperature	5 sec max, 2 mm from body	T <sub>sol</sub>	260	°C

#### Electrical and Optical Characteristics at T<sub>a</sub> = 25°C

Parameter	Test conditions	Symbol	Min.	Typ.	Max.	Unit
Forward voltage	I <sub>F</sub> = 350 mA	V <sub>F</sub>	-	3.4	4.2	V
Luminous flux	I <sub>F</sub> = 350 mA	Φ <sub>V</sub>	3	5	-	lm
Peak wavelength	I <sub>F</sub> = 350 mA	λ <sub>p</sub>	-	470	-	nm
Dominant wavelength	I <sub>F</sub> = 350 mA	λ <sub>d</sub>	-	470	-	nm
Spectral halfwidth	I <sub>F</sub> = 350 mA	Δλ	-	50	-	nm
Viewing angle	I <sub>F</sub> = 350 mA	φ	-	110	-	deg.
Thermal resistance junction to board	I <sub>F</sub> = 350 mA	R <sub>θJ-B</sub>	-	22	-	K/W